

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2789	(438/692).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/25 13:26
L2	1473	(257/e21.583).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/25 13:26
L3	165	WANG-HUI.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/25 13:27
L4	12	AFNAN-MUHAMMED .in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/25 13:27
L5	21	YIH-PEIHAUR .in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/25 13:27
L7	6	KOehler-Damon-L .in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/25 13:28
L8	4	YU-CHAW-CHI .in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/25 13:28

EAST Search History

S1	10	adaptive\$2 with electropolish\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:52
S2	86	adaptive\$2 with polish\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:52
S3	4	adaptive\$2 with polish\$3 same metal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/16 21:53
S4	31	adaptive\$2 with polish\$3 and metal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/16 21:53
S5	11	adaptive\$2 with polish\$3 and metal and thickness with measure\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/19 23:54
S6	1	adaptive\$2 with polish\$3 and metal and thickness with measure\$4 and electrolyte	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/19 23:54
S7	7	adaptive\$2 with electropolish\$3 and detector	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:52
S8	25	adaptive\$2 with polish\$3 and detector	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:52

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S9	0	adaptive\$2 with polish\$3 and optical sensor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:53
S10	0	adaptive\$2 with polish\$3 and metal density	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:53
S11	1	electropolish\$3 and detector same metal density	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:54
S12	4	electropolish\$3 and detector and metal density	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:59
S13	0	("66084095").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/23 19:57
S14	2	("6608495").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/23 19:57
S15	23	polish\$3 and detector and metal density	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 19:59
S16	1	polish\$3 and detector same metal density	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:29

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S17	0	end point detector and pixel thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:31
S18	1	end point detector and pixel and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:32
S19	1	end point detector and partition and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:32
S20	25	end point detector and matrix and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:35
S21	25	end point detector and matrices and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:36
S22	608	detector and matrices and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:36
S23	47	polish\$3 same detector and matrices and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:37
S24	161	polish\$3 and detector and matrices and thickness same map\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/23 20:36

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S25	57	"6234870"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/24 14:33
S26	491	electrolyte with polish\$3 and metal and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/24 15:11
S27	63	nozzle same electrolyte with polish\$3 and metal and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/24 15:11
S28	27	nozzle with electrolyte with polish\$3 and metal and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/24 15:11
S29	67	copper and polish\$3 and low-k and barrier and mask and plasma and electrolyte	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/24 18:19
S30	40	copper and polish\$3 and low-k and barrier and mask and plasma with etch\$3 and electrolyte	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2007/05/24 18:20